



Smoltek newsletter, June 2019

Summer is around the corner, and we would like to share some of the latest that has occurred during the last weeks of May.

Smoltek – Best IPO 2018! Award by SvD Börslus

Börslus, the stock market guide that is part of the leading Swedish daily newspaper SvD, has reviewed all 60 IPOs that were made last year. About half of those were categorized as micro-company IPO's. This is their analysis behind the recognition:

“From the subscription price onwards, the Smoltek share has climbed 240 percent. It is best in class and by far exceeds the average IPO return of minus five (-5) percent for the micro-company segment.”

At Smoltek we are of course very happy for this award that gives us even more motivation to continue our hard work within the areas of both technology and business development.



CEO, Anders Johansson at the Börslus awards.

Experienced member joins the Smoltek Board of Directors

Gustav Brismark is a new member of the board since elected at our Annual General Meeting that was held on May 16th. This is a very complementary addition as Gustav not only has extensive, but also recent, experience from licensing of intellectual property rights as former Chief Intellectual Property Officer at Ericsson. He has a long research background at Ericsson and has since 2004 been working on creation of business models for commercialization of Ericsson's patent portfolio.



New Member of the Board, Gustav Brismark

Patent No. 53 now granted

This, the 53rd of our granted patents, has been issued in South Korea and belongs to our Catalyst Diffusion core patent family, the patent relates to manufacturing of nanostructures. The general spectrum of the patent is that it provides a way to impact the resulted characteristics of the grown nanostructures.



R&D Engineer, Rickard Andersson with the Korean patent letter

ECTC 2019 – Sponsoring, presentation & networking

Just last week we were attending the ECTC 2019, in Las Vegas. This conference is one of the most important industry events of the year for the packaging community, and as Silver Sponsor of this year's event Smoltek was visible "all over" the conference area.

On the conference we also had a slot on the "interactive sessions" where we presented the latest from our development work on the CNF-MIM technology – for which we have now showed substantially improved numbers.

Vincent Desmaris, CTO of Smoltek said: *"I am very pleased to have presented the latest results of our CNF-MIM technology at ECTC2019, which demonstrates capacitance densities in excess of 350 nF/mm².*

It is important to expose our technology to the electronics packaging community. This enables our technical team to synchronize the further optimization of our CNF-MIM technology with the industry's actual needs."

Furthermore, ECTC 2019 provided an awesome networking environment that gave us time to meet up, and interact, with influential members of the important semiconductor packaging community – and we are already looking forward to next year's event.

Until next time, enjoy the upcoming summer weather!

/Sincerely,



Anders Johansson, CEO
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